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Diodes Incorporated DMN6066SSD-13

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Datasheet of DMN6066SSD-13 - MOSFET 2N-CH 60V 3.3A 8SO

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DMN6066SSD

60V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)}	I _D T _A = +25°C
60V	66mΩ @ V _{GS} = 10V	4.4A
800	97mΩ @ V _{GS} = 4.5V	3.6A

Features and Benefits

- Low on-resistance
- · Fast switching speed
- 100% Unclamped Inductive Switch (UIS) test in production
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Description and Applications

This MOSFET is designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

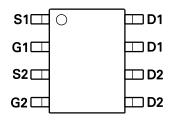
- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

Mechanical Data

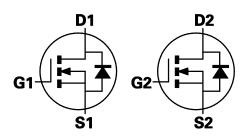
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



Top View



Top View



Equivalent Circuit

Ordering Information (Notes 4 & 5)

Part Number	Compliance	Case	Packaging
DMN6066SSD-13	Commercial	SO-8	2,500/Tape & Reel
DMN6066SSDQ-13	Automotive	SO-8	2,500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www. diodes.com/quality/product_grade_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

OHH N6066SD YY WW

SO-8

Oll = Manufacturer's Marking
N6066SD = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 09 = 2009)
WW = Week (01 - 53)

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DMN6066SSD

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	60	V	
Gate-Source Voltage		(Note 6)	V _{GS}	±20	V
Single Pulsed Avalanche En	ergy	(Note 13)	E _{AS}	37.5	mJ
Single Pulsed Avalanche Cu	rrent	(Note 13)	I _{AS}	5.0	A
		(Note 8)		4.4	
Continuous Drain Current	$V_{GS} = 10V$	$T_A = +70^{\circ}C \text{ (Note 8)}$	I_{D}	3.5	Α
		(Note 7)		3.3	
Pulsed Drain Current	$V_{GS} = 10V$	(Note 9)	I _{DM}	17.0	Α
Continuous Source Current	(Body diode)	(Note 8)	I _S	3.2	Α
Pulsed Source Current (Bod	y diode)	(Note 9)	I _{SM}	17.0	Α

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
	(Notes 7 & 10)		1.25 10	
Power Dissipation Linear Derating Factor	(Notes 7 & 11)	P _D	1.8 14.3	W mW/°C
	(Notes 8 & 10)		2.14 17.2	
Thermal Resistance, Junction to Ambient	(Notes 7 & 10) (Notes 7 & 11) (Notes 8 & 10)	R _θ JA	100 70 58	°C/W
Thermal Resistance, Junction to Lead	(Notes 10 & 12)	$R_{ heta JL}$	55	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C

Notes:

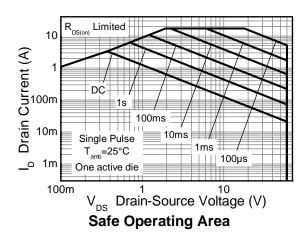
- 6. AEC-Q101 V_{GS} maximum is $\pm 16V$. 7. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 8. Same as note (3), except the device is measured at $t \le 10$ sec.
- 9. Same as note (3), except the device is pulsed with D = 0.02 and pulse width 300µs. The pulse current is limited by the maximum junction temperature.
- 10. For a dual device with one active die.

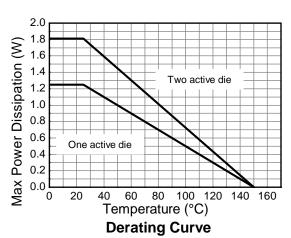
- 11. For a device with two active die running at equal power.
 12. Thermal resistance from junction to solder-point (at the end of the drain lead).
 13. UIS in production with L = 3.0mH, I_{AS} = 5.0A, R_{G} = 25 Ω , V_{DD} = 50V, starting T_{J} = +25°C.

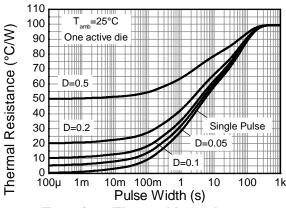


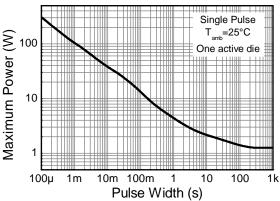


Thermal Characteristics









Transient Thermal Impedance

Pulse Power Dissipation



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Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$I_D = 250 \mu A, V_{GS} = 0 V$		
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μΑ	V _{DS} = 60V, V _{GS} =	= 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V _{GS} = ±20V, V _{DS}	V _{GS} = ±20V, V _{DS} = 0V	
ON CHARACTERISTICS								
Gate Threshold Voltage	V _{GS(th)}	1.0	_	3.0	V	$I_D = 250 \mu A, V_{DS}$	= V _{GS}	
Static Drain-Source On-Resistance (Note 14)			0.048	0.066	Ω	V _{GS} = 10V, I _D = 4	1.5A	
Static Drain-Source On-Resistance (Note 14)	R _{DS (ON)}		0.068	0.097	12	V_{GS} = 4.5 V , I_{D} =	3.5A	
Forward Transconductance (Notes 14 & 15)	g _{fs}	_	19.2	_	S	V _{DS} = 15V, I _D = 6	6A	
Diode Forward Voltage (Note 14)	V_{SD}	_	0.89	1.15	V	I _S = 4.5A, V _{GS} = 0V		
Reverse recovery time (Note 15)	t _{rr}		22.2	_	ns	I _S = 1.9A, di/dt= 100A/μs		
Reverse recovery charge (Note 15)	Qrr	_	16.9	_	nC			
DYNAMIC CHARACTERISTICS (Note 15)			•	•	•	•		
Input Capacitance	C _{iss}		502	_	pF	.,	0) /	
Output Capacitance	Coss	_	45.7	_	pF	V _{DS} = 30V, V _{GS} = 0V f= 1MHz		
Reverse Transfer Capacitance	C _{rss}	_	27.1	_	pF			
Total Gate Charge (Note 16)	Qg	_	5.4	_	nC	V _{GS} = 4.5V		
Total Gate Charge (Note 16)	Qg	_	10.3	_	nC	V _{DS} = 30V V _{DS} = 10V I _D = 4.5A		
Gate-Source Charge (Note 16)	Qgs	_	1.7	_	nC			
Gate-Drain Charge (Note 16)	Q _{qd}	_	3.2	_	nC			
Turn-On Delay Time (Note 16)	t _{D(on)}	_	2.7	_	ns			
Turn-On Rise Time (Note 16)	t _r		2.4	_	ns	V _{DD} = 30V, V _{GS} = 10V		
Turn-Off Delay Time (Note 16)	t _{D(off)}		14.7	_	ns	$I_D=1A, R_G \cong 6.0\Omega$		
Turn-Off Fall Time (Note 16)	t _f		5.4	_	ns			

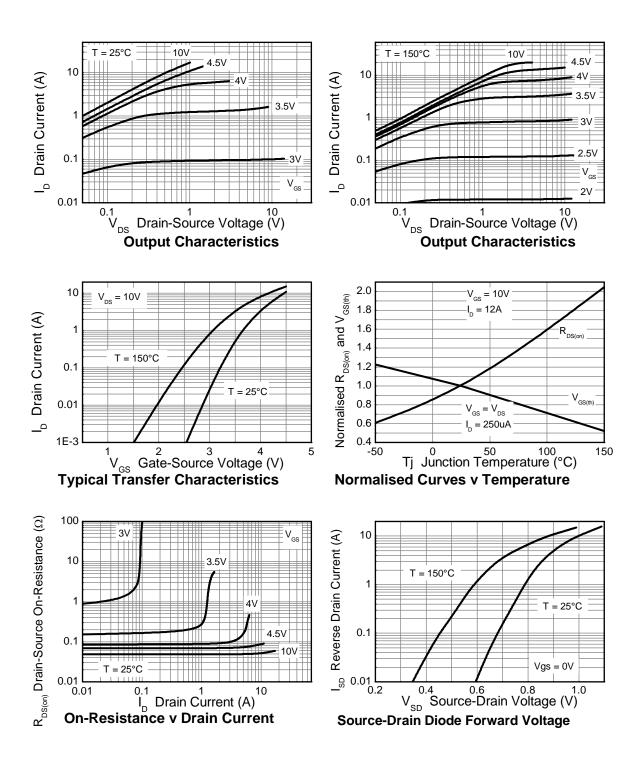
Notes:

- 14. Measured under pulsed conditions. Pulse width \leq 300 μ s; duty cycle \leq 2%.
- 15. For design aid only, not subject to production testing.16. Switching characteristics are independent of operating junction temperatures.



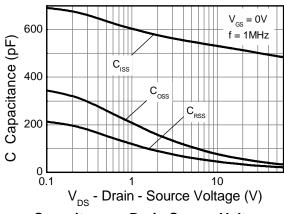


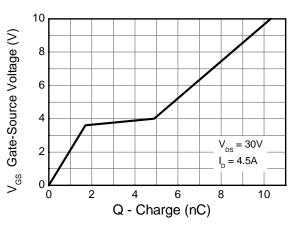
Typical Characteristics





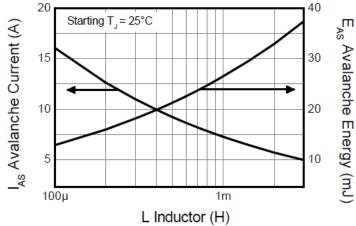
Typical Characteristics (continued)





Capacitance v Drain-Source Voltage

Gate-Source Voltage v Gate Charge

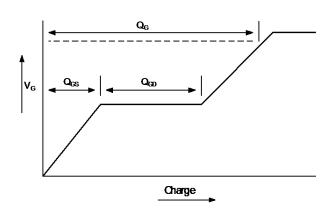


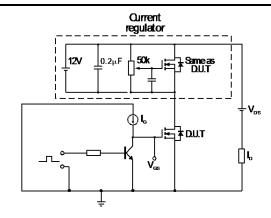
Single-Pulsed Avalanche Rating





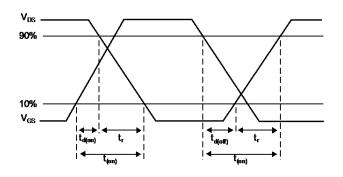
Test Circuits

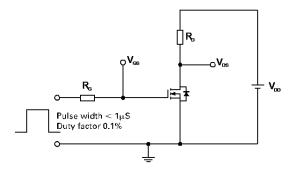




Basic gate charge waveform

Gate charge test circuit





Switching time waveforms

Switching time test circuit

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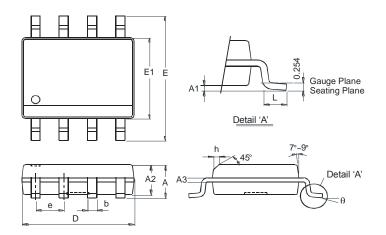
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Package Outline Dimensions

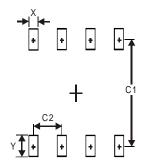
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SO-8					
Dim	Min	Max			
Α	-	1.75			
A1	0.10	0.20			
A2	1.30	1.50			
А3	0.15	0.25			
b	0.3	0.5			
D	D 4.85				
Е	5.90	6.10			
E1	3.85 3.95				
e 1.27 Typ					
h	-	0.35			
L	0.62	0.82			
Θ	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Υ	1.55
C1	5.4
C2	1.27



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